APPLICA	BLE STANDA	KD									
	OPERATING TEMPERATURE RANGE		-40 °C TO	105 °C	(NOTE1)	STORAGE TEMPERATU	IRE RANGE	-10 °C 7	ΓΟ +60 °	°C (NOTE	: 2)
RATING	CURRENT		1 A				Storage Humidity Range				
	VOLTAGE		250 V AC			Operating Hur	Relative humidity 85% (Not dewed)				
	70217102				FICATI	ONS					
ľ	TEM	TEST METHOD					REQUIREMENTS				AT
STRUCTU		<u> </u>	_					<u>-</u>			
EXAMINATION APPEARANO STRUCTURI	CE,	MEASUREMENT VIA VISUAL CHECK AND MEASURING INSTRUMENT				BE CONS	BE CONSISTENT WITH DRAWING.				X
FINISHING	EAND										
MARKING		VISUAL CONFIRMATION								Χ	Χ
	CAL CHARACT	MEASURE AT 1A DC.				20 m O M	720 O. MAY				_
	ESISTANCE	MEASURE AT 1A DC. MEASURE AT 20 mV AC MAX,					30 m Ω MAX 30 m Ω MAX				+-
UNDER LOV		0.1 mA(DC OR 1000Hz)				00 111 21 111	56 m2 www.				
INSULATION	N RESISTANCE	MEASURE AT 500 V DC				100 MΩ I	100 MΩ MIN.				_
VOLTAGE R	ESISTANCE	APPLY 650 V AC FOR 1 min.				NO BREA	NO BREAKDOWN.				<u> </u>
MECHANI	CAL CHARAC	TERIST	ICS							X	
	MECHANICAL	30 TIMES FOR EACH INSERTION AND					① CONTACT RESISTANCE: 60 mΩ MAX.				_
OPERATION	I RESISTANCE	WITHDRAWAL.					② NO DAMAGE, CRACK OR LOOSENESS OF PARTS. ① ELECTRICAL INSTANTANEOUS				 -
VIBRATION	RESISTANCE	FREQUENCY AT 20 TO 200 Hz, ACCELERATION AT 43.1 m/s ² ON EACH 3				_		S BELOW 10 μ		X	
		DIRECTIONS FOR 3h.				② CONTA	② CONTACT RESISTANCE: $60 \text{ m}\Omega$ MAX.				_
NADA OT DEGICTANIOS							③ NO DAMAGE, CRACK OR DISTORTION OF PARTS. ① ELECTRICAL INSTANTANEOUS				
IMPACT RESISTANCE		FREQUENCY AT 20 TO 50 Hz, ACCELERATION AT 66.6 m/s ² FOR 1h.						S BELOW 10 μ		X	-
						② CONTA	ACT RESIS	STANCE: 60 mg	MAX.	Х	_
		4551744						OR DISTORTION OF		X	
LOCK STRE	NGTH	APPLY A PULL FORCE WITH 98N MAX ON THE DIRECTION OF MATING AXIS.						ETELY DURING NG PARTS AFTER E		T. X	_
ENVIRON	MENTAL CHA			<u>. </u>		0					
HUMIDITY R	ESISTANCE	EXPOSE AT 60 °C, RH:90 ~ 95 % FOR 96h.			_	① CONTACT RESISTANCE: $60 \text{ m}\Omega$ MAX.				Τ-	
(STEADY ST	ATE)					_		SISTANCE:100		X	-
THERMAL SHOCK		TEMPERATURE: -40°C (30min) → ROOM TEMP					③ NO DAMAGE, CRACK OR DISTORTION OF PARTS. ① CONTACT RESISTANCE: 60 mΩ MAX.				+=
THE RIVINGE O	. IOOK	(5min)→105°C (30min)→ ROOM TEMP					② INSULATION RESISTANCE:100 M Ω MIN.				_
		,	ER 1000 CYCLES.					OR DISTORTION OF		X	_
HEAT RESIS	STANCE	EXPOSE AT 105°C FOR 300 h.				<u> </u>	① CONTACT RESISTANCE: 60 mΩ MAX. ② NO DAMAGE, CRACK OR DISTORTION OF PARTS.				_
COLD RESIS	STANCE	EXPOSE AT -40°C FOR 120 h.					① CONTACT RESISTANCE: 60 mΩ MAX. ② NO DAMAGE, CRACK OR DISTORTION OF PARTS.				_
RESISTANCE TO SO ₂ GAS		EXPOSE TO THE GAS WITH CONCENTRATION OF 500 PPM FOR 8h.					CONTACT RESISTANCE: 60 mΩ MAX.				_
RESISTANCE TO		PASS THROUGH THE SPECIFIED				NO DEFO	NO DEFORMATION OF APPEARANCE,				 - -
SOLDERING HEAT		TEMPERATURE PROFILE FOR 2 TIMES.					WITHOUT EXCESSIVE LOOSENESS OF TERMINALS.				
SODERABILITY		SOLDERING AT 245°C FOR 3sec.					NEW SOLDERING SURFACE SHALL COVER AT LEAST 95% OF THE SURFACE BEING				_
						IMMERSE				\perp	
A		SCRIPTION OF REVISIONS DE			DESIGNED		CHECKI	ED	DA	ΛTE	
REMARK (NOTE1) Include	de temperature rise o	caused by current-carrying. g-term storage state for the unused product					APPROVE			_	00321
(NOTE2) "STO	RAGE" means a lon						DESIGNED		UKUMO IAN KIM	2020032	
befo	re assembly to PCB.						DRAWN	+		-	00320
Note QT:Q	ualification Test	AT:Assurance Test X:Applicable Test			DRAWIN				67883-55-00		
184					PART NO.	RT NO. GT8E-10P-2H (55))		
HS	H25					CODE NO.	DDE NO. CL758-1007-0-55			Δ	1/1
	1	<u> </u>									